9-Bit TTL to ECL Translator

The MC10H/100H600 is a 9-bit, dual supply TTL to ECL translator. Devices in the Motorola 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The H600 features both ECL and TTL logic enable controls for maximum flexibility.

The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

- 9-Bit Ideal for Byte-Parity Applications
- Flow-Through Configuration
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- ECL and TTL Enable Inputs
- Dual Supply

TRUTH TABLE

ENTTL

Χ

Χ

Н

Н

D

Н

L

Н

L

ENECL

Н

Н

Χ

Χ

- 3.5 ns Max D to Q
- PNP TTL Inputs for Low Loading
- Choice of ECL Compatibility: MECL 10H (10Hxxx) or 100K (100Hxxx)

LOGIC SYMBOL ENECL -ENTTL: D0 Q0 Q1 D2 Q2 D3 Q3 TTL **ECL** D4 Q4 D5 Q5 D6 Q Q6 Н D7 L 07 Н L D8 08

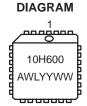


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PLCC-28 FN SUFFIX CASE 776



MARKING

A = Assembly Location

WL = Wafer Lot

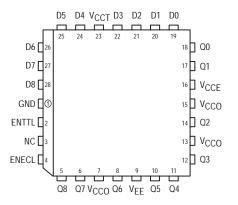
YY = Year

WW = Work Week

PIN NAMES

PIN	FUNCTION
GND VCCE VCCO VCCT VEE D0-D8 Q0-Q8 ENECL ENTTL	TTL Ground (0 V) ECL V _{CC} (0 V) ECL V _{CC} (0 V) — Outputs TTL Supply (+5.0 V) ECL Supply (-5.2/-4.5 V) Data Inputs (TTL) Data Outputs (ECL) Enable Control (ECL) Enable Control (TTL)

Pinout: 28-Lead PLCC (Top View)



ORDERING INFORMATION

Device	Package	Shipping				
MC10H600FN	PLCC-28	37 Units/Rail				
MC100H600FN	PLCC-28	37 Units/Rail				

DC CHARACTERISTICS: $V_{CCT} = 5.0 \text{ V} \pm 10\%$; $V_{EE} = -5.2 \text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2 \text{ V}$ to -5.5 V (100H version)

			0	°C	25	°C	75	°C		
Symbol	Parameter		Min	Max	Min	Max	Min	Max	Unit	Condition
	Power Supply Current									
IEE	ECL	10H 100H		-125 -122		-125 -123		-125 -132	mA	
ICCH ICCL	TTL			48 50		48 50		48 50	mA	

 $\textbf{AC CHARACTERISTICS:} \ \ V_{CCT} = 5.0 \ \ V \pm 10\%; \ \ V_{EE} = -5.2 \ \ V \pm 5\% \ \ (10 \text{H version}); \ \ V_{EE} = -4.2 \ \ V \ \ to \ -5.5 \ \ V \ \ (100 \text{H version})$

			0 °	C	25	°C	75	°C		
Symbol	Parameter		Min	Max	Min	Max	Min	Max	Unit	Condition
^t PLH	Propagation Delay	D	1.4	3.0	1.5	3.2	1.7	3.5	ns	50 Ω to -2.0 V
^t PHL	to Output	ENECL/ ENTTL	1.8	3.7	1.9	3.9	2.0	4.1	ns	50 Ω to -2.0 V
t _R	Output Rise/Fall Time 20%-80%		0.5	1.5	0.5	1.5	0.5	1.5	ns	50 Ω to -2.0 V

10H ECL DC CHARACTERISTICS: V_{CCT} = 5.0 V \pm 10%; V_{EE} = -5.2 V \pm 5%

		0 °	C	25	°C	75	°C		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit	Condition
I _{IH}	Input HIGH Current Input LOW Current	0.5	225	0.5	145	0.5	145	μA μA	
VIH VIL	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	
V _{OH} V _{OL}	Output HIGH Voltage Output LOW Voltage	-1020 -1950	-840 -1630	-980 -1950	-810 -1630	-920 -1950	-735 -1600	mV	50 Ω to −2.0 V

100H ECL DC CHARACTERISTICS: V_{CCT} = 5.0 V \pm 10%; V_{EE} = -4.2 V to -5.5 V

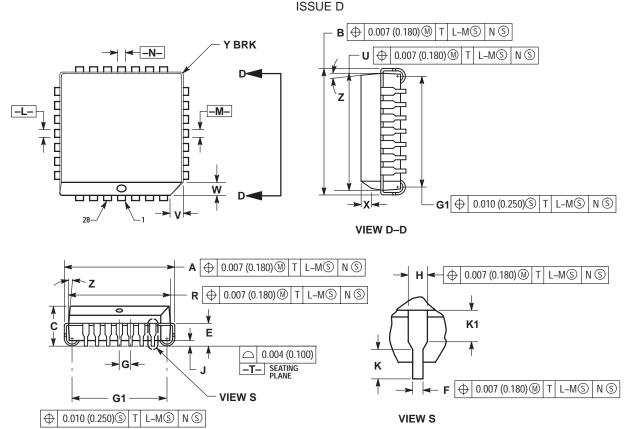
		0 °	С	25	°C	75	°C		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit	Condition
IIH IIL	Input HIGH Current Input LOW Current	0.5	225	0.5	145	0.5	145	μΑ μΑ	
VIH VIL	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	
VOH VOL	Output HIGH Voltage Output LOW Voltage	-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	mV	50 Ω to –2.0 V

 $\textbf{TTL DC CHARACTERISTICS:} \ \ V_{CCT} = 5.0 \ \ V \pm 10\%; \ \ V_{EE} = -5.2 \ \ V \pm 5\% \ \ (10 \ \ \text{H version}); \ \ V_{EE} = -4.2 \ \ V \ \ \text{to} \ -5.5 \ \ V \ \ (100 \ \ \text{H version})$

		0 °	С	25	°C	75	°C		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit	Condition
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V V	
lН	Input HIGH Current		20 100		20 100		20 100	μА	$V_{IN} = 2.7 \text{ V}$ $V_{IN} = 7.0 \text{ V}$
IIL	Input LOW Current		-0.6		-0.6		-0.6	mA	V _{IN} = 0.5 V
VIK	Input Clamp Voltage		-1.2		-1.2		-1.2	V	I _{IN} = -18 mA

PACKAGE DIMENSIONS

PLCC-28 **FN SUFFIX** PLASTIC PLCC PACKAGE CASE 776-02



- NOTES:
 1. DATUMS -L-, -M-, AND -N- DETERMINED 1. DATUMS -L., -M., AND -N. DE LERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T., SEATING PLANE.
 3. DIMENSIONS R AND U DO NOT INCLUDE.
 - MOLD FLASH. ALLOWABLE MOLD FLASH IS
 - 0.010 (0.250) PER SIDE.
- 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 5. CONTROLLING DIMENSION: INCH.

 6. THE PACKAGE TOP MAY BE SMALLER THAN . THE PACKAGE TOP MAY BE SMALLER TH
 THE PACKAGE BOTTOM BY UP TO 0.012
 (0.300). DIMENSIONS R AND U ARE
 DETERMINED AT THE OUTERMOST
 EXTREMES OF THE PLASTIC BODY
 EXCLUSIVE OF MOLD FLASH, TIE BAR
 BURRS, GATE BURRS AND INTERLEAD
 FLASH, BUT INCLUDING ANY MISMATCH
 ETMEEN THE TOP AND POTTOM OF THE BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- 7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

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	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
С	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050) BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040		1.02	

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